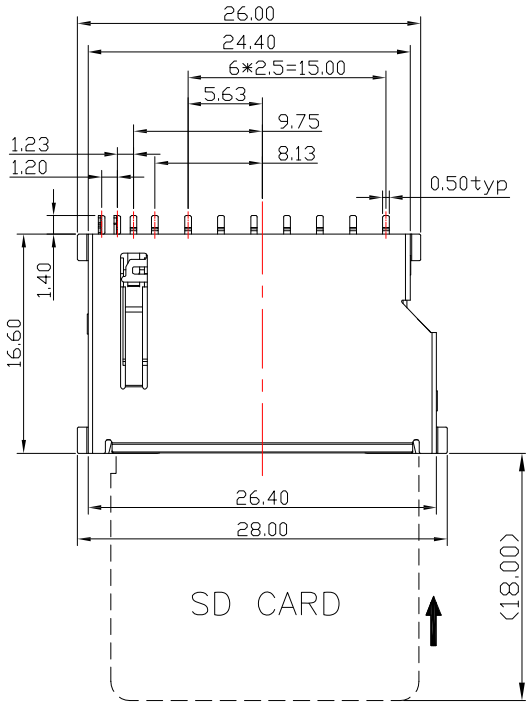
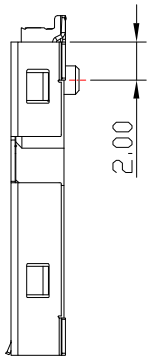
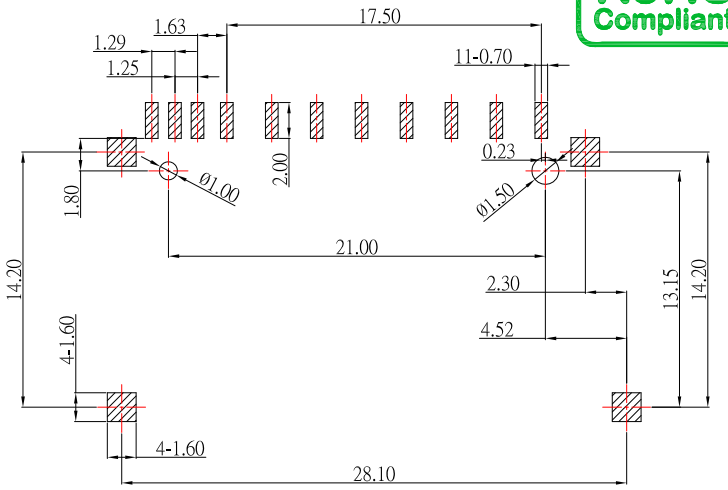
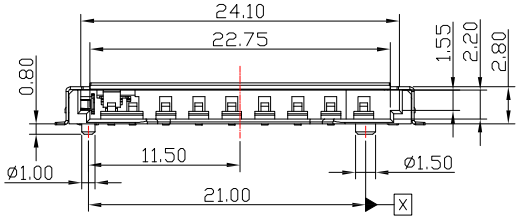
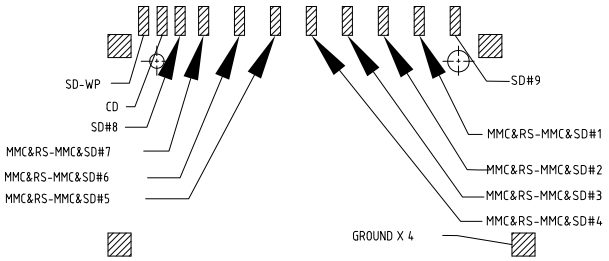






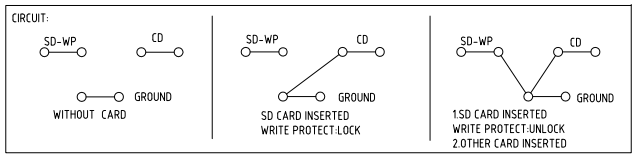
RECOMMEND PCB LAYOUT





PIN NO.	MEMORY CARD PIN NO.
MMC&RS-MMC&SD#1	MMC&RS-MMC/SD-1 (CD/DAT3)
MMC&RS-MMC&SD#2	MMC&RS-MMC/SD-2 (CMD)
MMC&RS-MMC&SD#3	MMC&RS-MMC/SD-3 (VSS1)
MMC&RS-MMC&SD#4	MMC&RS-MMC/SD-4 (VDD)
MMC&RS-MMC&SD#5	MMC&RS-MMC/SD-5 (CLK)
MMC&RS-MMC&SD#6	MMC&RS-MMC/SD-6 (VSS2)
MMC&RS-MMC&SD#7	MMC&RS-MMC/SD-7 (DAT0)
SD#8	SD-8 (DAT1)
SD#9	SD-9 (DAT2)

PIN ASSIGNMENT



SPECIFICATION

Electrical :

1.Current Rating: 0.5mA AC / DC Max

2.Voltage Rating: 125V AC / DC

3.Contact Resistance: 100 mΩ Max.

4.Insulation Resistance: 1,000 MΩ Min.

Environmental:

1.Operating Temperature: -20˚C ~ +60˚C.

Material:

1.Housing: High Temperature Thermal Plastics,UL 94V-0

2.Contact: Copper Alloy

3.Shell: Stainless Steel

Finish:

1.Contact: Plated Gold in Mating Area ;
Tin Plated on Solder Balls ;
Nickel under plated overall

2.Shell: Nickel under Plated surface layer

ITEM NO.	DESCRIPTION	DRAWN	DATE
4	更新PCB LAYOUT尺寸	Jack	090618
3	新增插卡尺寸	Jack	081618
2	更新尺寸	Jack	050417
1	更新料號	Jack	050217

CONTACT 建倚科技股份有限公司
CONTACT TECHNOLOGY CORP.

TOLERANCE UNLESS OTHERWISE STATED : Up to 5 ±0.2; Above 5 ~ 15 ±0.3; Above 15 ~ 30 ±0.4; Above 30 ~ 50 ±0.5; Angle ±0.3˚ | 3RD. ANGEL'S | UNITS MM

DRAWN BY: Jack Lu	DATE 09/06/18	MAT'L	
CHECKED BY: Jacky Chen	DATE 09/06/18	FINISH	
APPROVED BY: Tony Kao	DATE 09/06/18	SCALE 1 : 1	SHEET NO. 1 of 1

TITLE	CONNECTOR		
MODLE	SD Card 短體		
DWG NO.	SD-381200-S304	SIZE	A4
PART NO.	SD-381200-S304	VER	R4